## INTEGRATED CIRCUITS

# DATA SHEET

## 74ALVCH32501

36-bit universal bus transceiver with direction pin; 3-state

Product specification Supersedes data of 2000 Mar 16

2004 Oct 13





## 36-bit universal bus transceiver with direction pin; 3-state

## 74ALVCH32501

#### **FEATURES**

- 3-state non-inverting outputs for bus oriented applications
- Wide supply voltage range of 1.2 V to 3.6 V
- Complies with JEDEC standard no. 8-1A
- Current drive ±24 mA at 3.0 V
- Universal bus transceiver with D-type latches and D-type flip-flops capable of operating in transparent, latched or clocked mode
- CMOS low power consumption
- · Direct interface with TTL levels
- · All inputs have bus-hold circuitry
- Output drive capability 50 Ω transmission lines at 85 °C
- Plastic fine-pitch ball grid array package.

#### **DESCRIPTION**

The 74ALVCH32501 is a high-performance CMOS product designed for  $V_{CC}$  operation at 2.5 V and 3.3 V.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

The 74ALVCH32501 can be used as two 18-bit transceivers or one 36-bit transceiver featuring non-inverting 3-state bus compatible outputs in both send and receive directions. Data flow in each direction is controlled by output enable (OE $_{AB}$  and  $\overline{\text{OE}}_{BA}$ ), latch enable (LE $_{AB}$  and LE $_{BA}$ ), and clock inputs (CP $_{AB}$  and CP $_{BA}$ ). For A-to-B data flow, the device operates in the transparent mode when LE $_{AB}$  is HIGH. When input LE $_{AB}$  is LOW, the A data is latched if input CP $_{AB}$  is held at a HIGH or LOW level. If input LE $_{AB}$  is LOW, the A data is stored in the latch/flip-flop on the LOW-to-HIGH transition of CP $_{AB}$ . When input OE $_{AB}$  is HIGH, the outputs are active. When input OE $_{AB}$  is LOW, the outputs are in the high-impedance state.

Data flow for B-to-A is similar to that of A-to-B, but uses inputs  $\overline{OE}_{BA}$ , LE<sub>BA</sub> and CP<sub>BA</sub>. The output enables are complimentary (OE<sub>AB</sub> is active HIGH, and  $\overline{OE}_{BA}$  is active LOW).

To ensure the high-impedance state during power-up or power-down, pin  $\overline{OE}_{BA}$  should be tied to  $V_{CC}$  through a pull-up resistor and pin  $OE_{AB}$  should be tied to GND through a pull-down resistor. The minimum value of the resistor is determined by the current-sinking or current-sourcing capability of the driver.

### **QUICK REFERENCE DATA**

GND = 0 V;  $T_{amb}$  = 25 °C;  $t_r$  =  $t_f \le$  2.5 ns.

SYMBOL	PARAMETER	CONDITIONS	TYP.	UNIT
t <sub>PHL</sub> /t <sub>PLH</sub>	propagation delay A <sub>n</sub> to B <sub>n</sub> ; B <sub>n</sub> to A <sub>n</sub>	C <sub>L</sub> = 30 pF; V <sub>CC</sub> = 2.5 V	2.8	ns
		$C_L = 50 \text{ pF}; V_{CC} = 3.3 \text{ V}$	3.0	ns
C <sub>I</sub>	input capacitance		4.0	pF
C <sub>I/O</sub>	input/output capacitance		8.0	pF
C <sub>PD</sub>	power dissipation capacitance per latch	V <sub>I</sub> = GND to V <sub>CC</sub> ; note 1		
		outputs enabled	21	pF
		outputs disabled	3	pF

#### Note

1.  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$  where:

 $f_i$  = input frequency in MHz;

f<sub>o</sub> = output frequency in MHz;

C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in Volts;

N = number of inputs switching;

 $\Sigma(C_1 \times V_{CC}^2 \times f_0) = \text{sum of the outputs.}$ 

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### **FUNCTION TABLE**

See notes 1 and 2.

	INF	TUT		INTERNAL	OUTPUT	OPERATING MODE
nOE <sub>AB</sub>	nLE <sub>AB</sub>	nCP <sub>AB</sub>	nA <sub>n</sub>	REGISTERS	nB <sub>n</sub>	OPERATING WIDDE
L	Н	Х	Х	Х	Z	disabled
L	<b>\</b>	Х	h	Н	Z	disabled; latch data
L	↓	X	I	L	Z	
L	L	H or L	Х	NC	Z	disabled; hold data
L	L	1	h	Н	Z	disabled; clock data
L	L	<b>↑</b>	I	L	Z	
Н	Н	Х	Н	Н	Н	transparent
Н	Н	X	L	L	L	
Н	<b>\</b>	Х	h	Н	Н	latch data and display
Н	↓	X	I	L	L	
Н	L	1	h	Н	Н	clock data and display
Н	L	<b>↑</b>	I	L	L	
Н	L	H or L	Х	Н	Н	hold data and display
Н	L	H or L	X	L	L	

### Notes

- 1. A-to-B data flow is shown; B-to-A flow is similar but uses  $n\overline{OE}_{BA}$ ,  $nLE_{BA}$  and  $nCP_{BA}$ .
- 2. H = HIGH voltage level;

h = HIGH voltage level on set-up time prior to the enable or clock transition;

L = LOW voltage level;

I = LOW voltage level on set-up time prior to the enable or clock transition;

NC = no change;

X = don't care;

↑ = LOW-to-HIGH enable or clock transition;

 $\downarrow$  = HIGH-to-LOW enable or clock transition;

Z = high impedance OFF-state.

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### **ORDERING INFORMATION**

	PACKAGE					
TYPE NUMBER	TEMPERATURE RANGE	PINS	PACKAGE	MATERIAL	CODE	
74ALVCH32501EC	-40 °C to +85 °C	114	LFBGA114	plastic	SOT537-1	

### **PINNING**

SYMBOL	DESCRIPTION
nA <sub>n</sub>	data inputs
nB <sub>n</sub>	data outputs
GND	ground (0 V)
V <sub>CC</sub>	DC supply voltage
nOE <sub>AB</sub>	output enable inputs A to B (active HIGH)
$n\overline{OE}_{BA}$	output enable inputs B to A (active LOW)
nLE <sub>AB</sub>	latch enable inputs A to B
nLE <sub>BA</sub>	latch enable inputs B to A
nCP <sub>AB</sub>	clock input A to B
nCP <sub>BA</sub>	clock input B to A

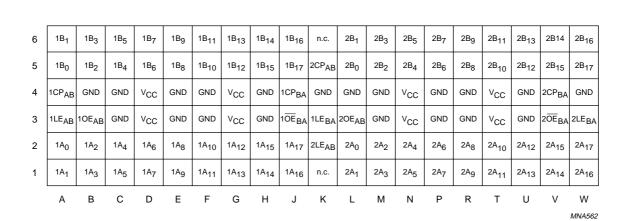
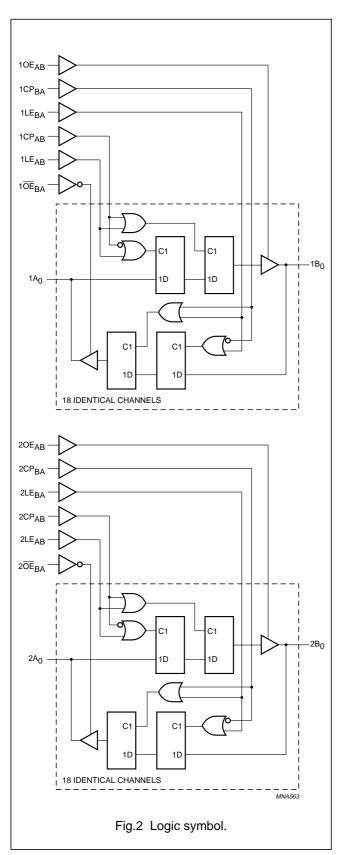
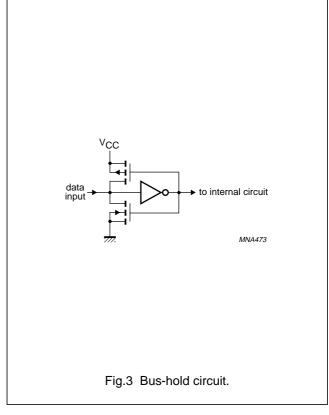


Fig.1 Pin configuration.

# 36-bit universal bus transceiver with direction pin; 3-state

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### **RECOMMENDED OPERATING CONDITIONS**

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>CC</sub>	supply voltage	2.5 V range (for maximum speed performance at 30 pF output load)		2.7	V
		3.3 V range (for maximum speed performance at 50 pF output load)	3.0	3.6	V
VI	input voltage		0	V <sub>CC</sub>	V
Vo	output voltage	output HIGH or LOW state	0	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	+85	°C
t <sub>r</sub> , t <sub>f</sub>	input rise and fall time ratios	V <sub>CC</sub> = 1.2 V to 2.7 V	0	20	ns/V
	(Δt/ΔV)	V <sub>CC</sub> = 2.7 V to 3.6 V	0	10	ns/V

### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134); voltages are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>CC</sub>	supply voltage		-0.5	+4.6	V
VI	input voltage	for control pins; note 1	-0.5	+4.6	V
		for data input pins; note 1	-0.5	V <sub>CC</sub> + 0.5	V
I <sub>IK</sub>	input diode current	V <sub>I</sub> < 0 V	_	-50	mA
I <sub>OK</sub>	output clamping diode current	V <sub>O</sub> < 0 V; note 1	_	50	mA
Vo	output voltage	see note 1	-0.5	V <sub>CC</sub> + 0.5	V
Io	output sink current	$V_O = 0 \text{ V to } V_{CC}$	_	-50	mA
I <sub>CC</sub> , I <sub>GND</sub>	V <sub>CC</sub> or GND current		_	±100	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}; \text{ note } 2$	_	1000	mW

### Notes

- 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
- 2. Above 55  $^{\circ}\text{C}$  the value of  $P_{tot}$  derates linearly with 1.8 mW/K.

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### **DC CHARACTERISTICS**

Over recommended operating conditions; voltages are referenced to GND (ground = 0 V).

CAMBOI	DADAMETED	TEST CONDITIONS		BAIL I	T) (D) (1)	NA A V		
SYMBOL	PARAMETER	OTHER	V <sub>CC</sub> (V)	MIN.	<b>TYP.</b> <sup>(1)</sup>	MAX.	UNIT	
T <sub>amb</sub> = -40	) °C to +85 °C	1					•	
V <sub>IH</sub>	HIGH-level input		2.3 to 2.7	1.7	1.2	_	V	
	voltage		2.7 to 3.6	2.0	1.5	_	V	
V <sub>IL</sub>	LOW-level input		2.3 to 2.7	_	1.2	0.7	V	
	voltage		2.7 to 3.6	_	1.5	0.8	٧	
V <sub>OH</sub>	HIGH-level output	$V_I = V_{IH}$ or $V_{IL}$						
	voltage	$I_{O} = -100 \mu\text{A}$	2.3 to 3.6	V <sub>CC</sub> - 0.2	V <sub>CC</sub>	-	V	
		$I_O = -6 \text{ mA}$	2.3	$V_{CC} - 0.3$	$V_{CC} - 0.08$	-	V	
		$I_{O} = -12 \text{ mA}$	2.3	V <sub>CC</sub> - 0.6	V <sub>CC</sub> - 0.26	-	V	
		$I_{O} = -12 \text{ mA}$	2.7	V <sub>CC</sub> - 0.5	V <sub>CC</sub> - 0.14	-	V	
		$I_{O} = -12 \text{ mA}$	3.0	V <sub>CC</sub> - 0.6	V <sub>CC</sub> - 0.09	-	V	
		$I_{O} = -24 \text{ mA}$	3.0	V <sub>CC</sub> – 1.0	V <sub>CC</sub> - 0.28	-	V	
V <sub>OL</sub>	LOW-level output	$V_I = V_{IH}$ or $V_{IL}$						
	voltage	I <sub>O</sub> = 100 μA	2.3 to 3.6	_	GND	0.20	V	
		$I_O = 6 \text{ mA}$	2.3	_	0.07	0.40	V	
		I <sub>O</sub> = 12 mA	2.3	_	0.15	0.70	V	
		I <sub>O</sub> = 12 mA	2.7	_	0.14	0.40	V	
		I <sub>O</sub> = 24 mA	3.0	_	0.27	0.55	V	
I <sub>I</sub>	input leakage current	$V_I = V_{CC}$ or GND	2.3 to 3.6	_	±0.1	±5	μΑ	
I <sub>OZ</sub>	3-state output OFF-state current	$V_I = V_{IH}$ or $V_{IL}$ ; $V_O = V_{CC}$ or GND; note 2	2.3 to 3.6	_	0.1	±10	μΑ	
I <sub>CC</sub>	quiescent supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A	2.3 to 3.6	_	0.4	80	μΑ	
Δl <sub>CC</sub>	additional quiescent supply current given per data I/O pin with bus-hold	$V_1 = V_{CC} - 0.6 \text{ V};$ $I_O = 0 \text{ A}$	2.7 to 3.6	_	150	750	μА	
I <sub>BHL</sub>	bus-hold LOW	V <sub>I</sub> = 0.7 V; note 3	2.3	45	_	_	μΑ	
	sustaining current	V <sub>I</sub> = 0.8 V; note 3	3.0	75	150	_	μΑ	
I <sub>BHH</sub>	bus-hold HIGH	V <sub>I</sub> = 1.7 V; note 3	2.3	-45	_	_	μΑ	
	sustaining current	V <sub>I</sub> = 2.0 V; note 3	3.0	-75	-175	_	μΑ	
I <sub>BHLO</sub>	bus-hold LOW overdrive current	note 3	3.6	500	_	_	μΑ	
Івнно	bus-hold HIGH overdrive current	note 3	3.6	-500	-	_	μΑ	

### **Notes**

- 1. All typical values are at  $V_{CC}$  = 3.3 V and  $T_{amb}$  = 25 °C.
- 2. For I/O ports, the parameter  $I_{OZ}$  includes the input leakage current.
- 3. Valid for data inputs of bus-hold parts.

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## **AC CHARACTERISTICS**

 $T_{amb}$  = -40 °C to +85 °C; GND = 0 V

CVMDOL	DADAMETED	TEST CONDITIONS		NAIN!	T\/D			
SYMBOL	PARAMETER	WAVEFORMS	CL	MIN.	TYP.	MAX.	UNIT	
V <sub>CC</sub> = 2.3	V to 2.7 V; $t_r = t_f \le 2.0 \text{ ns}$ ; note 1		!	!	!		-	
t <sub>PHL</sub> /t <sub>PLH</sub>	propagation delay							
	nA <sub>n</sub> to nB <sub>n</sub> ; nB <sub>n</sub> to nA <sub>n</sub>	see Figs 4 and 8	30 pF	1.0	2.8	5.1	ns	
	nLE <sub>BA</sub> to nA <sub>n</sub> ; nLE <sub>AB</sub> to nB <sub>n</sub>	see Figs 5 and 8	30 pF	1.1	3.5	6.1	ns	
	nCP <sub>BA</sub> to nA <sub>n</sub> ; nCP <sub>AB</sub> to nB <sub>n</sub>	see Figs 5 and 8	30 pF	1.0	3.3	6.1	ns	
t <sub>PZH</sub> /t <sub>PZL</sub>	3-state output enable time nOEAB to nBn	see Figs 6 and 8	30 pF	1.0	2.5	5.8	ns	
	3-state output enable time nOE <sub>BA</sub> to nA <sub>n</sub>	see Figs 6 and 8	30 pF	1.3	2.8	6.3	ns	
t <sub>PHZ</sub> /t <sub>PLZ</sub>	3-state output disable time nOE <sub>AB</sub> to nB <sub>n</sub>	see Figs 6 and 8	30 pF	1.5	2.5	6.2	ns	
	3-state output disable time nOE <sub>BA</sub> to nA <sub>n</sub>	see Figs 6 and 8	30 pF	1.3	2.5	5.3	ns	
t <sub>W</sub>	nLE <sub>AB</sub> or nLE <sub>BA</sub> pulse width HIGH	see Figs 5 and 8	30 pF	3.3	0.8	_	ns	
	nCP <sub>AB</sub> or nCP <sub>BA</sub> pulse width HIGH or LOW	see Figs 5 and 8	30 pF	3.3	2.0	_	ns	
t <sub>su</sub>	set-up time nA <sub>n</sub> before nCP <sub>AB</sub> ↑ or nB <sub>n</sub> before nCP <sub>BA</sub> ↑	see Figs 7 and 8	30 pF	1.7	0.1	_	ns	
	set-up time CP HIGH or LOW nA <sub>n</sub> before nLE <sub>AB</sub> ↓ or nB <sub>n</sub> before nLE <sub>BA</sub> ↓	see Figs 7 and 8	30 pF	1.1	0.1	_	ns	
t <sub>h</sub>	hold time nA <sub>n</sub> after nCP <sub>AB</sub> ↑ or nB <sub>n</sub> after nCP <sub>BA</sub> ↑	see Figs 7 and 8	30 pF	1.7	0.3	_	ns	
	hold time CP HIGH or LOW nA <sub>n</sub> after nLE <sub>AB</sub> ↓ or nB <sub>n</sub> after nLE <sub>BA</sub> ↓	see Figs 7 and 8	30 pF	1.6	0.3	_	ns	
f <sub>max</sub>	maximum clock frequency	see Figs 5 and 8	30 pF	150	330	_	MHz	
	V; $t_r = t_f ≤ 2.5 \text{ ns}$ ; note 2		!	!				
t <sub>PHL</sub> /t <sub>PLH</sub>	propagation delay							
	nA <sub>n</sub> to nB <sub>n</sub> ; nB <sub>n</sub> to nA <sub>n</sub>	see Figs 4 and 8	50 pF	_	3.0	4.6	ns	
	nLE <sub>BA</sub> to nA <sub>n</sub> ; nLE <sub>AB</sub> to nB <sub>n</sub>	see Figs 5 and 8	50 pF	_	3.6	5.3	ns	
	nCP <sub>BA</sub> to nA <sub>n</sub> ; nCP <sub>AB</sub> to nB <sub>n</sub>	see Figs 5 and 8	50 pF	_	3.4	5.6	ns	
t <sub>PZH</sub> /t <sub>PZL</sub>	3-state output enable time nOEAB to nBn	see Figs 6 and 8	50 pF	_	2.7	5.3	ns	
	3-state output enable time nOE <sub>BA</sub> to nA <sub>n</sub>	see Figs 6 and 8	50 pF	_	3.3	6.0	ns	
t <sub>PHZ</sub> /t <sub>PLZ</sub>	3-state output disable time nOE <sub>AB</sub> to nB <sub>n</sub>	see Figs 6 and 8		_	3.6	5.7	ns	
	3-state output disable time nOE <sub>BA</sub> to nA <sub>n</sub>	see Figs 6 and 8	50 pF	_	3.3	4.6	ns	
t <sub>W</sub>	pulse width nLE <sub>AB</sub> or nLE <sub>BA</sub> HIGH	see Figs 5 and 8	50 pF	3.3	0.7	_	ns	
	pulse width nCP <sub>AB</sub> or nCP <sub>BA</sub> HIGH or LOW	see Figs 5 and 8	50 pF	3.3	1.4	_	ns	
t <sub>su</sub>	set-up time nA <sub>n</sub> before nCP <sub>AB</sub> ↑ or nB <sub>n</sub> before nCP <sub>BA</sub> ↑	see Figs 7 and 8	50 pF	+1.4	-0.1	_	ns	
	set-up time CP HIGH or LOW nA <sub>n</sub> before nLE <sub>AB</sub> ↓ or nB <sub>n</sub> before nLE <sub>BA</sub> ↓	see Figs 7 and 8	50 pF	+1.0	-0.2	_	ns	

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OVMDOL	DADAMETED	TEST CONDITIONS		84151	TVD	MAY	
SYMBOL	PARAMETER	WAVEFORMS	CL	MIN.	TYP.	MAX.	UNIT
t <sub>h</sub>	hold time nA <sub>n</sub> after nCP <sub>AB</sub> ↑ or nB <sub>n</sub> after nCP <sub>BA</sub> ↑	see Figs 7 and 8	50 pF	1.6	0.3	_	ns
	hold time CP HIGH or LOW nA <sub>n</sub> after nLE <sub>AB</sub> ↓ or nB <sub>n</sub> after nLE <sub>BA</sub> ↓	see Figs 7 and 8	50 pF	1.5	0.1	_	ns
$f_{\text{max}}$	maximum clock frequency	see Figs 5 and 8	50 pF	150	333	_	MHz
$V_{CC} = 3.0$	V to 3.6 V; $t_r = t_f \le 2.5 \text{ ns}$ ; note 3						
t <sub>PHL</sub> /t <sub>PLH</sub>	propagation delay						
	nA <sub>n</sub> to nB <sub>n</sub> ; nB <sub>n</sub> to nA <sub>n</sub>	see Figs 4 and 8	50 pF	1.0	3.0	4.2	ns
	nLE <sub>BA</sub> to nA <sub>n</sub> ; nLE <sub>AB</sub> to nB <sub>n</sub>	see Figs 5 and 8	50 pF	1.3	3.4	4.8	ns
	nCP <sub>BA</sub> to nA <sub>n</sub> ; nCP <sub>AB</sub> to nB <sub>n</sub>	see Figs 5 and 8	50 pF	1.4	3.3	4.9	ns
t <sub>PZH</sub> /t <sub>PZL</sub>	3-state output enable time nOEAB to nBn	see Figs 6 and 8	50 pF	1.0	2.4	4.6	ns
	3-state output enable time nOE <sub>BA</sub> to nA <sub>n</sub>	see Figs 6 and 8	50 pF	1.1	2.5	5.0	ns
t <sub>PHZ</sub> /t <sub>PLZ</sub>	3-state output disable time nOE <sub>AB</sub> to nB <sub>n</sub>	see Figs 6 and 8	50 pF	1.4	2.9	5.0	ns
	3-state output disable time nOE <sub>BA</sub> to nA <sub>n</sub>	see Figs 6 and 8	50 pF	1.3	3.1	4.2	ns
t <sub>W</sub>	pulse width nLE <sub>AB</sub> or nLE <sub>BA</sub> HIGH	see Figs 5 and 8	50 pF	3.3	0.9	_	ns
	pulse width nCP <sub>AB</sub> or nCP <sub>BA</sub> HIGH or LOW	see Figs 5 and 8	50 pF	3.3	1.1	_	ns
t <sub>su</sub>	set-up time nA <sub>n</sub> before nCP <sub>AB</sub> ↑ or nB <sub>n</sub> before nCP <sub>BA</sub> ↑	see Figs 7 and 8	50 pF	+1.3	-0.3	_	ns
	set-up time CP HIGH or LOW nA <sub>n</sub> before nLE <sub>AB</sub> ↓ or nB <sub>n</sub> before nLE <sub>BA</sub> ↓	see Figs 7 and 8	50 pF	1.0	0.3	_	ns
t <sub>h</sub>	hold time nA <sub>n</sub> after nCP <sub>AB</sub> ↑ or nB <sub>n</sub> after nCP <sub>BA</sub> ↑	see Figs 7 and 8	50 pF	+1.3	-0.4	_	ns
	hold time CP HIGH or LOW $nA_n$ after $nLE_{AB} \downarrow$ or $nB_n$ after $nLE_{BA} \downarrow$	see Figs 7 and 8	50 pF	1.2	0.1	_	ns
f <sub>max</sub>	maximum clock frequency	see Figs 5 and 8	50 pF	150	340	_	MHz

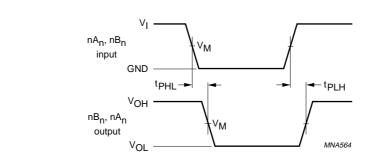
### **Notes**

- 1. All typical values are measured at  $V_{CC}$  = 2.5 V and  $T_{amb}$  = 25 °C.
- 2. All typical values are measured at  $T_{amb}$  = 25 °C.
- 3. All typical values are measured at  $V_{CC}$  = 3.3 V and  $T_{amb}$  = 25 °C.

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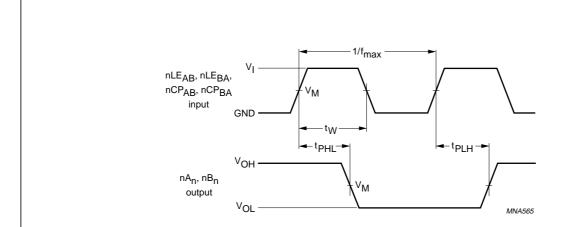
### **AC WAVEFORMS**



V <sub>CC</sub>	V <sub>M</sub>	$V_{l}$
2.3 V to 2.7 V	$0.5 \times V_{CC}$	$V_{CC}$
2.7 V	1.5 V	2.7 V
3.0 V to 3.6 V	1.5 V	2.7 V

 $V_{OL}$  and  $V_{OH}$  are typical output voltage drop that occur with the output load.

Fig.4 Input nA<sub>n</sub>, nB<sub>n</sub> to output nB<sub>n</sub>, nA<sub>n</sub> propagation delay times.



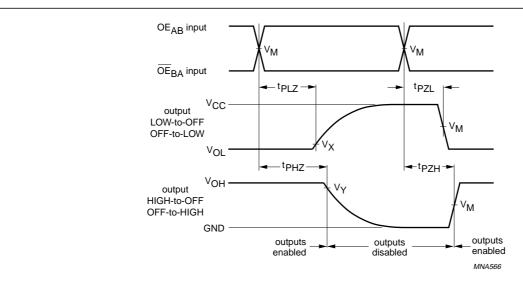
V <sub>CC</sub>	V <sub>M</sub>	Vı
2.3 V to 2.7 V	$0.5 \times V_{CC}$	V <sub>CC</sub>
2.7 V	1.5 V	2.7 V
3.0 V to 3.6 V	1.5 V	2.7 V

 $V_{\text{OL}}$  and  $V_{\text{OH}}$  are typical output voltage drop that occur with the output load.

Fig.5 Latch enable input (nLE<sub>AB</sub>, nLE<sub>BA</sub>) and clock input (nCP<sub>AB</sub>, nCP<sub>BA</sub>) to output propagation delays and their pulse width.

# 36-bit universal bus transceiver with direction pin; 3-state

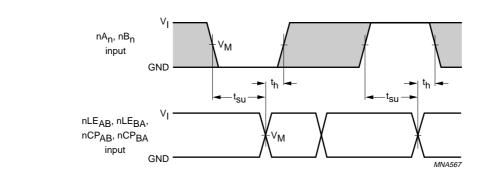
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V <sub>CC</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>	VI
2.3 V to 2.7 V	$0.5 \times V_{CC}$	V <sub>OL</sub> + 150 mV	V <sub>OH</sub> – 150 mV	V <sub>CC</sub>
2.7 V	1.5 V	V <sub>OL</sub> + 300 mV	$V_{OH} - 300 \text{ mV}$	2.7 V
3.0 V to 3.6 V	1.5 V	V <sub>OL</sub> + 300 mV	$V_{OH} - 300 \text{ mV}$	2.7 V

 $V_{\text{OL}}$  and  $V_{\text{OH}}$  are typical output voltage drop that occur with the output load.

Fig.6 3-state enable and disable times.



The shaded areas indicate when the input is permitted to change for predictable output performance.

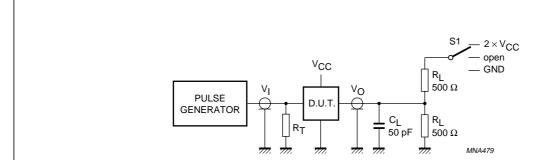
V <sub>CC</sub>	V <sub>M</sub>	$V_{l}$
2.3 V to 2.7 V	$0.5 \times V_{CC}$	$V_{CC}$
2.7 V	1.5 V	2.7 V
3.0 V to 3.6 V	1.5 V	2.7 V

 $V_{OL}$  and  $V_{OH}$  are typical output voltage drop that occur with the output load.

Fig.7 Data set-up and hold times for the  $nA_n$  and  $nB_n$  inputs to the  $nLE_{AB}$ ,  $nLE_{BA}$ ,  $nCP_{AB}$  and  $nCP_{BA}$  inputs.

# 36-bit universal bus transceiver with direction pin; 3-state

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TEST	S1
t <sub>PLH</sub> /t <sub>PHL</sub>	open
t <sub>PLZ</sub> /t <sub>PZL</sub>	$2 \times V_{CC}$
t <sub>PHZ</sub> /t <sub>PZH</sub>	GND

Definitions for test circuit:

R<sub>L</sub> = Load resistor.

C<sub>L</sub> = Load capacitance including jig and probe capacitance.

 $R_T$  = Termination resistance should be equal to the output impedance  $Z_0$  of the pulse generator.

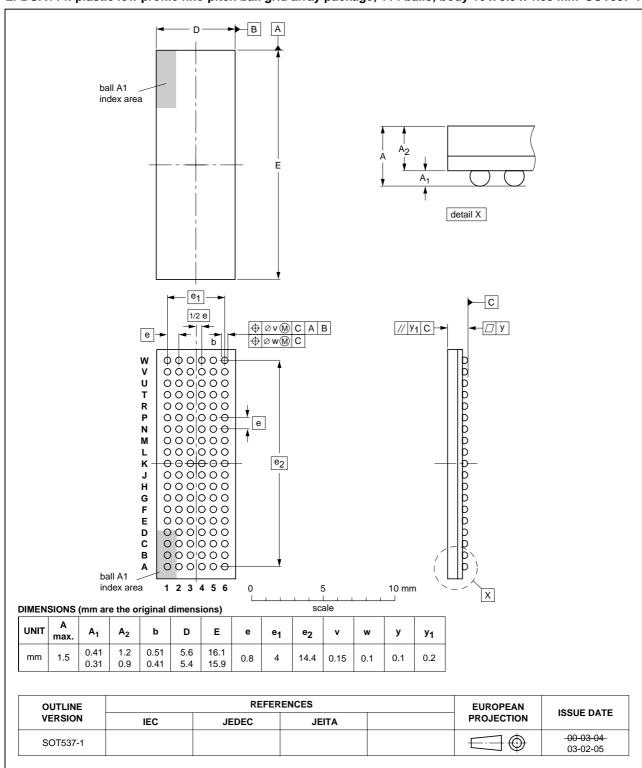
Fig.8 Load circuitry for switching times.

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### **PACKAGE OUTLINE**

LFBGA114: plastic low profile fine-pitch ball grid array package; 114 balls; body 16 x 5.5 x 1.05 mm SOT537-1



## 36-bit universal bus transceiver with direction pin; 3-state

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#### **DATA SHEET STATUS**

LEVEL	DATA SHEET STATUS <sup>(1)</sup>	PRODUCT STATUS(2)(3)	DEFINITION
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